

# AP9435GK-HF-VB Datasheet P-Channel 35 V (D-S) MOSFET

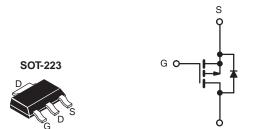
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
- 35	0.040 at $V_{GS} = -10 \text{ V}$	- 6.2	9.8 nC			
- 35	0.048 at V <sub>GS</sub> = - 4.5 V	- 5.1	9.0110			

# FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE



P-Channel MOSFET

#### **APPLICATIONS**

- · Load Switches, Adaptor Switch
  - Notebook PCs

ABSOLUTE MAXIMUM RATINGS (TA	_ = 25 °C, unless oth	erwise noted)	)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 35	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	_ v
	T <sub>C</sub> = 25 °C		- 6.2	
Continuous Drain Current (T. – 150 °C)	T <sub>C</sub> = 70 °C	l .	- 4.8	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l lo	- 4.5 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		- 3.4 <sup>a, b</sup>	A
Pulsed Drain Current		I <sub>DM</sub>	- 20	^
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		- 3.5	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	- 2.1 <sup>a, b</sup>	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 10	
Single-Pulse Avalanche Energy	L = 0.1 IIII	E <sub>AS</sub>	5	mJ
	T <sub>C</sub> = 25 °C		4.2	
Maximum Bayer Dissination	T <sub>C</sub> = 70 °C	] <sub>B</sub>	2.7	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	$P_{D}$	2.5 <sup>a, b</sup>	VV
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	40	50	°C/W
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	24	30	C/VV

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 85 °C/W.
- d. Based on  $T_C$  = 25 °C.

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1



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 35			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 42		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		4.6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.6		- 1.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Osta Valla va Busin Osmani	I <sub>DSS</sub>	V <sub>DS</sub> = - 35 V, V <sub>GS</sub> = 0 V			- 1		
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 35 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 5	μΑ	
On-State Drain Current <sup>a</sup> I <sub>D(on)</sub>		$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 10			Α	
Durin Course Co. Clata Basistana a	Б	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		0.040			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4 A		0.048		Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 5 A		14		S	
Dynamic <sup>b</sup>				l .	1		
Input Capacitance	C <sub>iss</sub>			970			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		120		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			95			
Tabal Oaks Obarras	0	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		23	35	, ,,	
Total Gate Charge	$Q_g$			9.8	16		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5 \text{ A}$		3		nC	
Gate-Drain Charge	Q <sub>gd</sub>			5.2		1	
Gate Resistance	$R_{g}$	f = 1 MHz	1.0	5.5	11	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			7	14		
Rise Time	t <sub>r</sub>	$V_{DD} = -20 \text{ V}, R_1 = 4 \Omega$		12	24	1	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		30	60	1	
Fall Time	t <sub>f</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -10 \text{ V}, H_g = 1.22$		9	18	1	
Turn-On Delay Time	t <sub>d(on)</sub>			44	80	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = -20 \text{ V, R}_{L} = 4 \Omega$		33	60	1	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		28	55		
Fall Time	t <sub>f</sub>			13	25		
Drain-Source Body Diode Characterist	ics					•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 3.5		
Pulse Diode Forward Current	I <sub>SM</sub>				- 20	A	
Body Diode Voltage V <sub>SD</sub>		I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.76	- 1.2	V	
Body Diode Reverse Recovery Time				27	50	ns	
Body Diode Reverse Becovery Charge Q				19	35	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		14			
Reverse Recovery Rise Time	t <sub>b</sub>			13		ns	

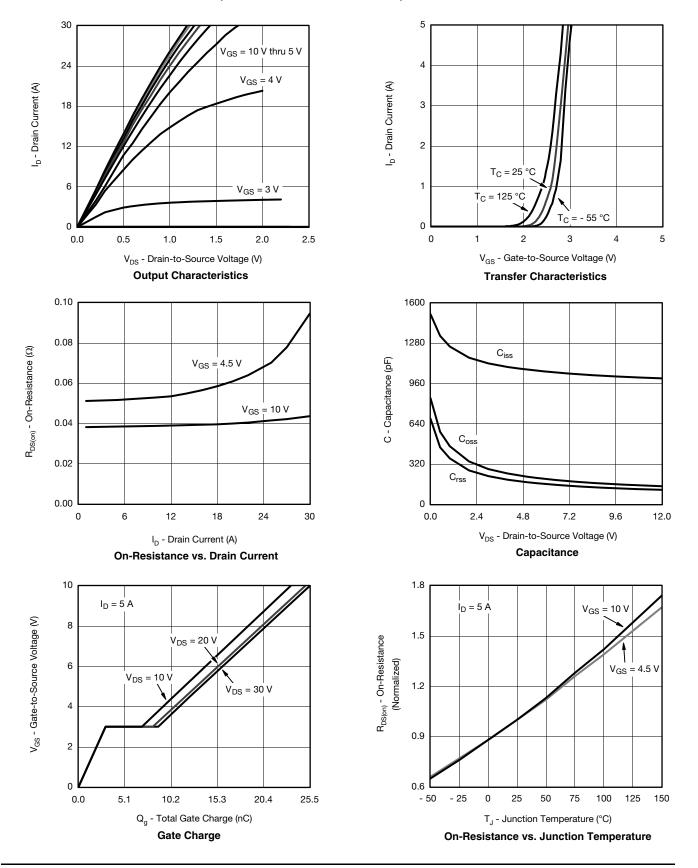
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

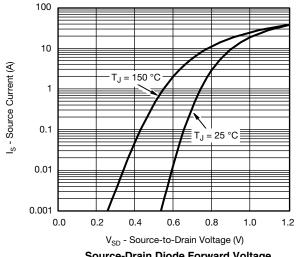


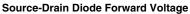
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

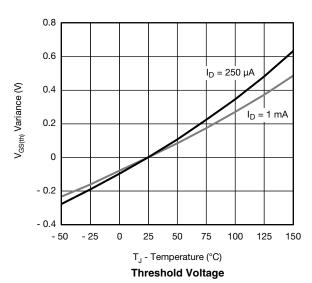


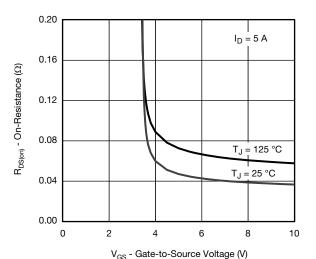


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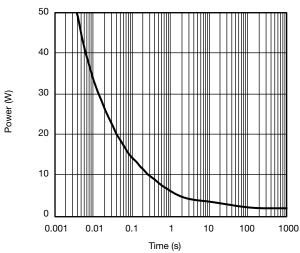




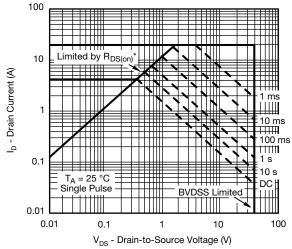




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

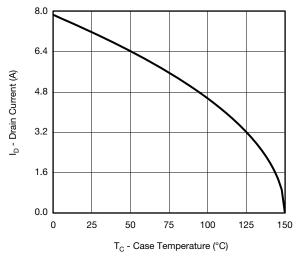


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

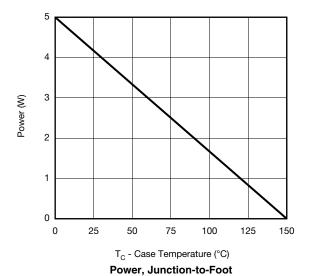
Safe Operating Area

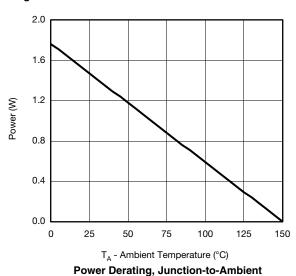


### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### **Current Derating\***





\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

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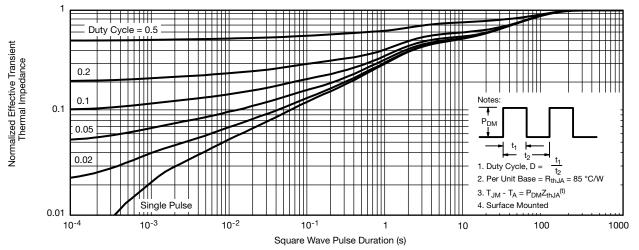
limit.

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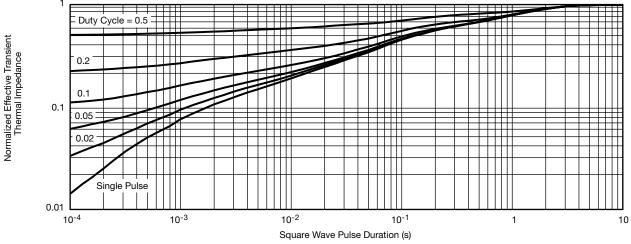
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



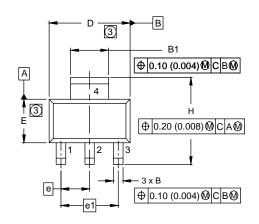
Normalized Thermal Transient Impedance, Junction-to-Ambient

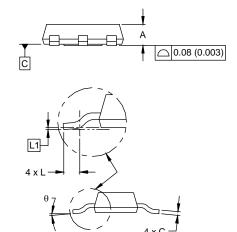


Normalized Thermal Transient Impedance, Junction-to-Foot



## **SOT-223 (HIGH VOLTAGE)**





	MILLIN	METERS	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	1.55	1.80	0.061	0.071
В	0.65	0.85	0.026	0.033
B1	2.95	3.15	0.116	0.124
С	0.25	0.35	0.010	0.014
D	6.30	6.70	0.248	0.264
E	3.30	3.70	0.130	0.146
е	2.30	BSC	0.090	5 BSC
e1	4.60	BSC	0.181	BSC
Н	6.71	7.29	0.264	0.287
L	0.91	-	0.036	-
L1	0.061 BSC		0.002	4 BSC
θ	-	10'	-	10'

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

#### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



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